#### 查询74LV374N供应商

DATA SHEET

INTEGRATED CIRCUITS OBJI

74LV374 Octal D-type flip-flop; positive edge-trigger (3-State)

Product specification Supersedes data of 1996 Feb IC24 Data Handbook 1997 Mar 20







## 74LV374

#### **FEATURES**

- Wide operating voltage: 1.0 to 5.5V
- Optimized for Low Voltage applications: 1.0 to 3.6V
- Accepts TTL input levels between V<sub>CC</sub> = 2.7V and V<sub>CC</sub> = 3.6V
- Typical V<sub>OLP</sub> (output ground bounce)  $< 0.8V @ V_{CC} = 3.3V$ ,  $T_{amb} = 25^{\circ}C$
- Typical V<sub>OHV</sub> (output V<sub>OH</sub> undershoot) > 2V @ V<sub>CC</sub> = 3.3V, T<sub>amb</sub> = 25°C
- Common 3-State output enable input
- Output capability: bus driver
- I<sub>CC</sub> category: MSI

### QUICK REFERENCE DATA

### GND = 0V; $T_{amb} = 25^{\circ}C$ ; $t_r = t_f \le 2.5$ ns

#### DESCRIPTION

The 74LV374 is a low-voltage Si-gate CMOS device and is pin and function compatible with 74HC/HCT374.

The 74LV374 is an octal D-type flip-flop featuring separate D-type inputs for each flip-flop and 3-state outputs for bus oriented applications. A clock (CP) and an output enable (OE) input are common to all flip-flops.

The eight flip-flops will store the state of their individual D-inputs that meet the set-up and hold times requirements on the LOW-to-HIGH CP transition.

When OE is LOW, the contents of the eight flip-flops is available at the outputs. When  $\overline{OE}$  is HIGH, the outputs go to the high impedance OFF-state. Operation of the OE input does not affect the state of the flip-flops.

SYMBOL PARAMETER		PARAMETER CONDITIONS		
t <sub>PHL</sub> /t <sub>PLH</sub>	Propagation delay CP to Q <sub>n</sub>	C <sub>L</sub> = 15pF V <sub>CC</sub> = 3.3V	14	ns
f <sub>max</sub>	Maximum clock frequency		77	MHz
Cl	Input capacitance		3.5	pF
C <sub>PD</sub>	Power dissipation capacitance per flip-flop	Notes 1 and 2	25	pF

#### NOTES:

1. C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W) P<sub>D</sub> = C<sub>PD</sub> × V<sub>CC</sub><sup>2</sup> x f<sub>i</sub> +  $\Sigma$  (C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) where: f<sub>i</sub> = input frequency in MHz; C<sub>L</sub> = output load capacity in pF;  $f_o =$  output frequency in MHz;  $V_{CC} =$  supply voltage in V;  $\Sigma (C_L \times V_{CC}^2 \times f_o) =$  sum of the outputs.

2. The condition is  $V_I = GND$  to  $V_{CC}$ 

#### ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
20-Pin Plastic DIL	–40°C to +125°C	74LV374 N	74LV374 N	SOT146-1
20-Pin Plastic SO	–40°C to +125°C	74LV374 D	74LV374 D	SOT163-1
20-Pin Plastic SSOP Type II	–40°C to +125°C	74LV374 DB	74LV374 DB	SOT339-1

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#### PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1	ŌĒ	Output enable input (active-LOW)
2, 5, 6, 9, 12, 15, 16, 19	Q0 to Q7	3-State flip-flop outputs
3, 4, 7, 8, 13, 14, 17, 18	D0 to D7	Data inputs
10	GND	Ground (0V)
11	СР	Clock input (LOW-to-HIGH, edge- triggered)
20	V <sub>CC</sub>	Positive supply voltage

### **FUNCTION TABLE**

OPERATING	11	NPUT	S	INTERNAL	OUTPUTS
MODES	OE	СР	Dn	FLIP-FLOPS	Q0 to Q7
Load and read register	L L	$\stackrel{\uparrow}{\uparrow}$	l h	L H	L H
Load register and disable outputs	H H	$\uparrow \\ \uparrow$	l h	L H	Z Z

Н HIGH voltage level =

= HIGH voltage level one set-up time prior to the LOW-to-HIGH CP transition

LOW voltage level =

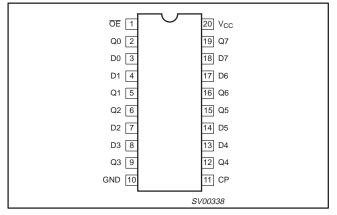
LOW voltage level one set-up time prior to the LOW-to-HIGH CP transition

High impedance OFF-state =

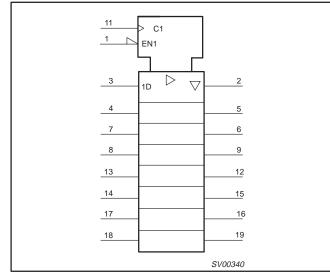
Z ↑ = LOW-to-HIGH clock transition

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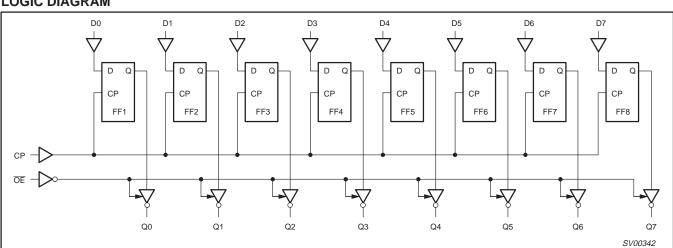
### **PIN CONFIGURATION**



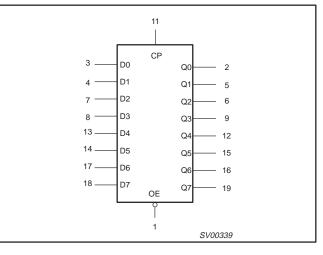
### LOGIC SYMBOL (IEEE/IEC)



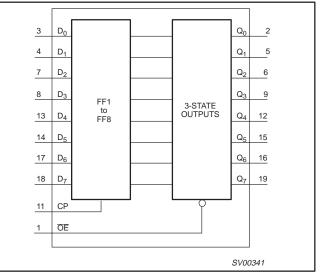
### LOGIC DIAGRAM



### LOGIC SYMBOL



### **FUNCTIONAL DIAGRAM**



## 74LV374

#### ABSOLUTE MAXIMUM RATINGS<sup>1, 2</sup>

In accordance with the Absolute Maximum Rating System (IEC 134)

Voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +7.0	V
±Ι <sub>ΙΚ</sub>	DC input diode current	$V_{\rm I} < -0.5 \text{ or } V_{\rm I} > V_{\rm CC} + 0.5 \text{V}$	20	mA
±Іок	DC output diode current	$V_{\rm O}$ < -0.5 or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5V	50	mA
±ΙΟ	DC output source or sink current – standard outputs – bus driver outputs	$-0.5V < V_O < V_{CC} + 0.5V$	25 35	mA
±I <sub>GND</sub> , ±I <sub>CC</sub>	DC V <sub>CC</sub> or GND current for types with –standard outputs –bus driver outputs		50 70	mA
T <sub>stg</sub>	Storage temperature range		-65 to +150	°C
P <sub>TOT</sub>	Power dissipation per package –plastic DIL –plastic mini-pack (SO) –plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: -40 to +125°C above +70°C derate linearly with 12mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

### **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP.	MAX	UNIT
V <sub>CC</sub>	DC supply voltage	See Note1	1.0	3.3	5.5	V
VI	Input voltage		0	-	V <sub>CC</sub>	V
V <sub>O</sub>	Output voltage		0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	Operating ambient temperature range in free air	See DC and AC characteristics per device	-40 -40		+85 +125	°C
t <sub>r</sub> , t <sub>f</sub>	Input rise and fall times except for Schmitt-trigger inputs	$\begin{array}{l} V_{CC} = 1.0V \mbox{ to } 2.0V \\ V_{CC} = 2.0V \mbox{ to } 2.7V \\ V_{CC} = 2.7V \mbox{ to } 3.6V \\ V_{CC} = 3.6V \mbox{ to } 5.5V \end{array}$	- - -	- - - -	500 200 100 50	ns/V

NOTES:

1. The LV is guaranteed to function down to  $V_{CC}$  = 1.0V (input levels GND or  $V_{CC}$ ); DC characteristics are guaranteed from  $V_{CC}$  = 1.2V to  $V_{CC}$  = 5.5V.

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### DC CHARACTERISTICS FOR THE LV FAMILY

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

		LIMI   TEST CONDITIONS -40°C to +85°C						4	
SYMBOL	PARAMETER	TEST CONDITIONS				-40°C to +125°C			
			MIN	TYP <sup>1</sup>	MAX	MIN	MAX		
		$V_{CC} = 1.2V$	0.9			0.9			
$V_{IH}$	HIGH level Input	$V_{CC} = 2.0 V$	1.4			1.4		V	
. 14	voltage	V <sub>CC</sub> = 2.7 to 3.6V	2.0			2.0			
		$V_{CC} = 4.5 \text{ to } 5.5 \text{V}$	0.7*V <sub>CC</sub>			0.7*V <sub>CC</sub>			
		$V_{CC} = 1.2V$			0.3		0.3		
VIL	LOW level Input	$V_{CC} = 2.0V$			0.6		0.6	l v	
۴IL	voltage	V <sub>CC</sub> = 2.7 to 3.6V			0.8		0.8	_ `	
		V <sub>CC</sub> = 4.5 to 5.5			0.3*V <sub>CC</sub>		0.3*V <sub>CC</sub>		
		$V_{CC}$ = 1.2V; $V_I = V_{IH}$ or $V_{IL}$ , $-I_O = 100\mu A$		1.2					
		$V_{CC} = 2.0V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$	1.8	2.0		1.8			
V <sub>OH</sub>	HIGH level output voltage; all outputs	$V_{CC} = 2.7V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$	2.5	2.7		2.5		V	
	·····g-, -··p-···	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$	2.8	3.0		2.8		1	
		$V_{CC} = 4.5V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$	4.3	4.5		4.3		1	
V <sub>OH</sub>	HIGH level output voltage;	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} -I_O = 6mA$	2.40	2.82		2.20		v	
VОН	STANDARD outputs	$V_{CC} = 4.5 V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 12 \text{mA}$	3.60	4.20		3.50		ĺ	
V <sub>OH</sub>	HIGH level output voltage; BUS driver	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 8\text{mA}$	2.40	2.82		2.20		v	
	outputs	$V_{CC} = 4.5V; V_I = V_{IH} \text{ or } V_{IL;} -I_O = 16\text{mA}$	3.60	4.20		3.50		$\square$	
	LOW level output voltage; all outputs	$V_{CC}$ = 1.2V; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O$ = 100 $\mu$ A		0					
		$V_{CC}$ = 2.0V; $V_I$ = $V_{IH}$ or $V_{IL}$ ; $I_O$ = 100 $\mu$ A		0	0.2		0.2	V	
V <sub>OL</sub>		$V_{CC} = 2.7V; V_I = V_{IH} \text{ or } V_{IL;} I_O = 100 \mu A$		0	0.2		0.2		
		$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$		0	0.2		0.2		
		$V_{CC} = 4.5V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$		0	0.2		0.2		
V <sub>OL</sub>	LOW level output voltage;	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} I_O = 6mA$		0.25	0.40		0.50	v	
VOL	STANDARD outputs	$V_{CC}$ = 4.5V; $V_{I}$ = $V_{IH}$ or $V_{IL}$ ; $I_{O}$ = 12mA		0.35	0.55		0.65	ľ	
	LOW level output	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 8mA$		0.20	0.40		0.50		
V <sub>OL</sub>	voltage; BUS driver outputs	$V_{CC} = 4.5 V; V_I = V_{IH} \text{ or } V_{IL;} I_O = 16 \text{mA}$		0.35	0.55		0.65	V	
I <sub>I</sub>	Input leakage current	$V_{CC} = 5.5V; V_I = V_{CC} \text{ or GND}$			1.0		1.0	μA	
I <sub>OZ</sub>	3-State output OFF-state current	$V_{CC} = 5.5V; V_I = V_{IH} \text{ or } V_{IL;}$ $V_O = V_{CC} \text{ or } GND$			5		10	μΑ	
	Quiescent supply current; SSI	$V_{CC} = 5.5V; V_{I} = V_{CC} \text{ or GND}; I_{O} = 0$			20.0		40		
Icc	Quiescent supply current; flip-flops	$V_{CC} = 5.5V; V_I = V_{CC} \text{ or GND}; I_O = 0$			20.0		80	μΑ	
	Quiescent supply current; MSI	$V_{CC} = 5.5V; V_I = V_{CC} \text{ or GND}; I_O = 0$			20.0		160		
Icc	Quiescent supply current; LSI	$V_{CC} = 5.5V; V_I = V_{CC} \text{ or GND}; I_O = 0$			500		1000	μΑ	
$\Delta I_{CC}$	Additional quiescent supply current per input	$V_{CC} = 2.7V$ to 3.6V; $V_{I} = V_{CC} - 0.6V$			500		850	μΑ	

#### NOTE:

1. All typical values are measured at  $T_{amb}$  = 25°C.

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### AC CHARACTERISTICS

GND = 0V;  $t_r$  =  $t_f$  = 2.5ns; C\_L = 50pF; R\_L = 500  $\Omega$ 

SYMBOL	PARAMETER	WAVEFORM	CONDITION	_	LIMITS 40 to +85 °	С		<b>IITS</b> <b>+125</b> ℃	UNIT
		1 1	V <sub>CC</sub> (V)	MIN	TYP	MAX	MIN	MAX	
			1.2	-	90	-	-	-	
			2.0	-	31	39	-	49	
t <sub>PHL</sub> /t <sub>PLH</sub>	Propagation delay CP to Qn	Figure 1	2.7	-	23	29	-	36	ns
		1 1	3.0 to 3.6	-	17 <sup>2</sup>	23	-	29	
			4.5 to 5.5	-	-	19	-	24	
			1.2	-	75	-	-	-	
		1 [	2.0	-	26	34	-	43	
t <sub>PZH</sub> /t <sub>PZL</sub>	Propagation delay	Figure 2	2.7	-	19	25	-	31	ns
		1 1	3.0 to 3.6	-	14 <sup>2</sup>	20	-	25	
		1 1	4.5 to 5.5	-	-	17	-	21	
	Propagation delay OE to Qn		1.2	-	80	-	-	-	ns
		Figure 2	2.0	-	29	39	-	48	
t <sub>PHZ</sub> /t <sub>PLZ</sub>			2.7	-	22	29	-	36	
			3.0 to 3.6	-	17 <sup>2</sup>	24	-	29	
			4.5 to 5.5	-	-	20	-	24	
			2.0	34	12	-	41	-	ns
t <sub>W</sub>	Clock pulse width HIGH or LOW	Figure 1	2.7	25	9	-	30	-	
		1 1	3.0 to 3.6	20	7 <sup>2</sup>	-	24	-	
			1.2	-	25	-	-	-	
	Set-up time		2.0	22	9	-	26	-	
t <sub>su</sub>	Dn to CP	Figure 3	2.7	16	6	-	19	-	ns
		1 1	3.0 to 3.6	13	5 <sup>2</sup>	-	15	-	
			1.2	-	-10	-	-	-	
	Hold time		2.0	5	-3	-	5	-	
t <sub>h</sub>	Dn to CP	Figure 3	2.7	5	-2	-	5	-	ns
			3.0 to 3.6	5	-2 <sup>2</sup>	-	5	-	
		1 1	2.0	15	40	-	12	-	
f <sub>max</sub>	Maximum clock pulse frequency	Figure 2	2.7	19	58	-	16	-	MHz
			3.0 to 3.6	24	70 <sup>2</sup>	-	20	-	

NOTE:

1. Unless otherwise stated, all typical values are at  $T_{amb}$  = 25°C.

2. Typical value measured at V<sub>CC</sub> = 3.3V.

3. Typical value measured at  $V_{CC} = 5.0V$ .

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#### **AC WAVEFORMS**

 $V_M$  = 1.5V at  $V_{CC} \ge 2.7V \le 3.6V$   $V_M$  = 0.5V \*  $V_{CC}$  at  $V_{CC} < 2.7V$  and  $\ge 4.5V$   $V_{OL}$  and  $V_{OH}$  are the typical output voltage drop that occur with the output load.

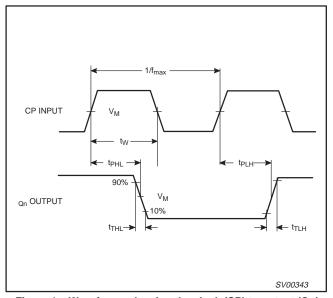


Figure 1. Waveforms showing the clock (CP) to output (Qn) propagation delays, the clock pulse width, output transition times and the maximum clock pulse frequency

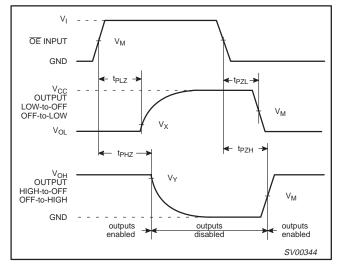


Figure 2. Waveforms showing the 3-state enable and disable times

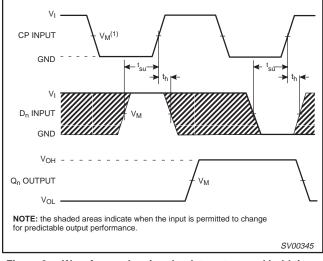


Figure 3. Waveforms showing the data set-up and hold times for the Dn input to the CP input

#### NOTE:

The shaded areas indicate when the input is permitted to change for predictable output performance.

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### **TEST CIRCUIT**

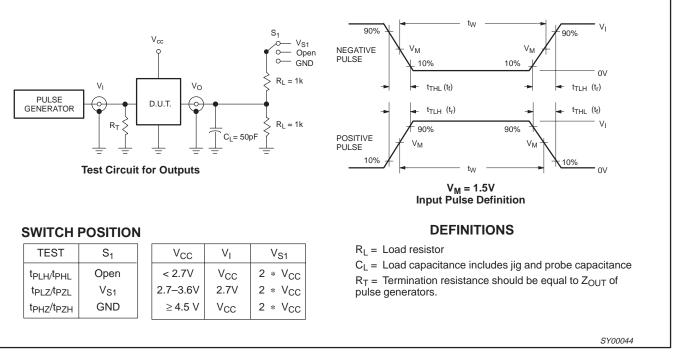
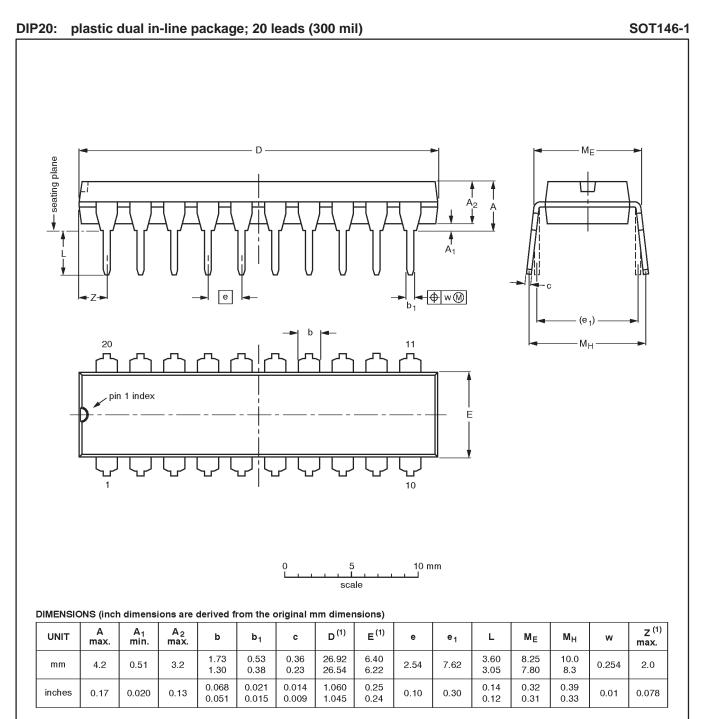


Figure 4. Load circuitry for switching times

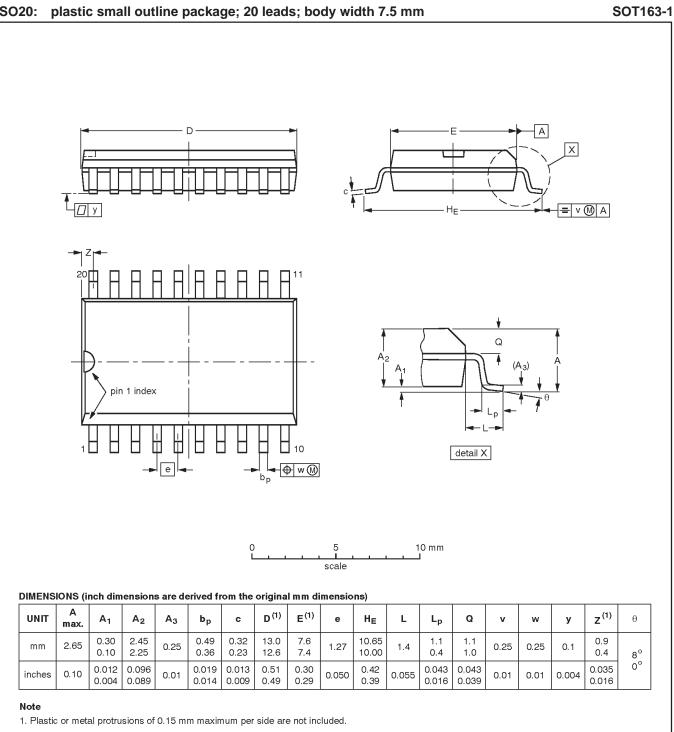


#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT146-1			SC603		<del>-92-11-17</del> 95-05-24

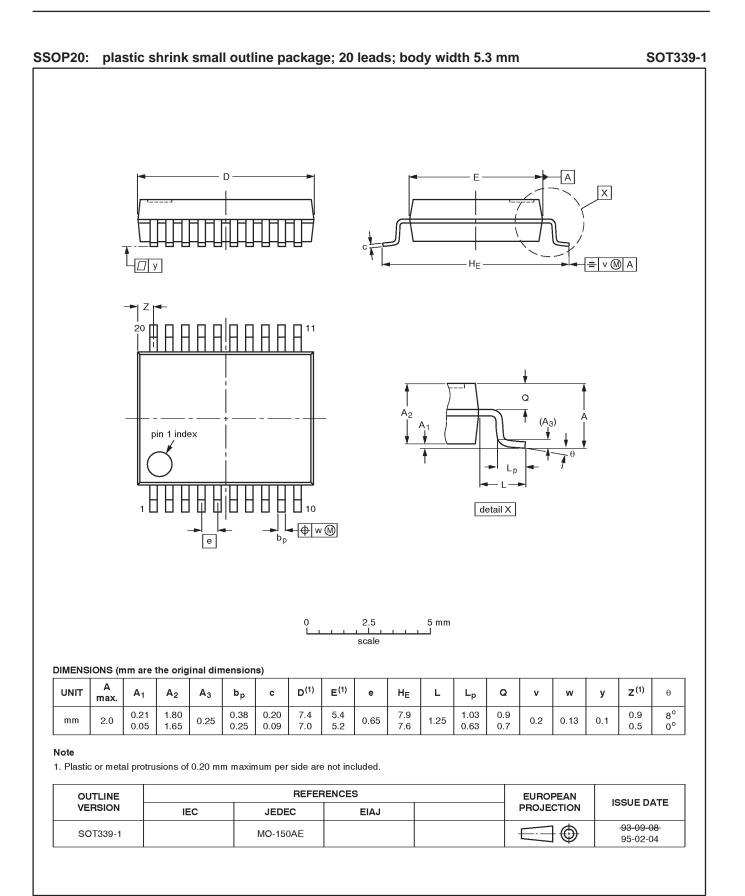
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#### SO20:

REFERENCES OUTLINE EUROPEAN **ISSUE DATE** VERSION PROJECTION IEC JEDEC EIAJ 92-11-17 SOT163-1 075E04 MS-013AC E  $\odot$ 95-01-24

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DEFINITIONS					
Data Sheet Identification	Product Status	Definition			
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